

## STB75NF75L

N-channel 75V - 0.009Ω - 75A - D<sup>2</sup>PAK STripFET™ II Power MOSFET

#### **Features**

Туре	V <sub>DSS</sub>	R <sub>DS(on)</sub>	I <sub>D</sub>
STB75NF75L	75V	<0.011Ω	75A

- Exceptional dv/dt capability
- 100% avalanche tested
- Low threshold drive

#### **Description**

This MOSFET series realized with STMicroelectronics unique STripFET process has specifically been designed to minimize input capacitance and gate charge. It is therefore suitable as primary switch in advanced highefficiency, high-frequency isolated DC-DC converters for Telecom and Computer applications. It is also intended for any applications with low gate drive requirements.

### **Applications**

Switching applications

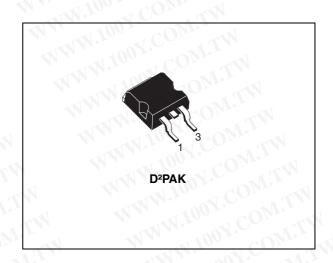


Figure 1. Internal schematic diagram

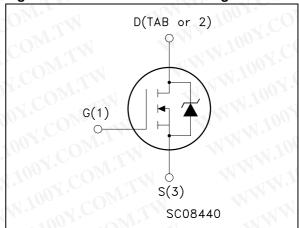


Table 1. Device summary

Order code	Marking	Package	Packaging
STB75NF75LT4	B75NF75L	D²PAK	Tape & reel

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OM.TV	Revision history

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MMM.100Y.COM.TW STB75NF75L **Electrical ratings** 

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## **Electrical ratings**

Table 2. **Absolute maximum ratings** 

Symbol	Parameter	Value	Unit
$V_{DS}$	Drain-source voltage (V <sub>GS</sub> = 0)	75	V
V <sub>GS</sub>	Gate-source voltage	± 15	V
I <sub>D</sub> <sup>(1)</sup>	Drain current (continuous) at T <sub>C</sub> = 25°C	75	Α
l <sub>D</sub>	Drain current (continuous) at T <sub>C</sub> = 100°C	70	Α
I <sub>DM</sub> <sup>(2)</sup>	Drain current (pulsed)	300	Α
P <sub>TOT</sub>	Total dissipation at T <sub>C</sub> = 25°C	300	W
	Derating factor	2 CO	W/°C
dv/dt (3)	Peak diode recovery voltage slope	10	V/ns
E <sub>AS</sub> (4)	Single pulse avalanche energy	680	mJ
T <sub>J</sub> T <sub>stg</sub>	Operating junction temperature Storage temperature	-55 to 175	°C
Pulse widt I <sub>SD</sub> ≤75A,	nited by package the limited by safe operating area di/dt $\leq$ 500A/ $\mu$ s, $V_{DD} \leq V_{(BR)DSS}$ , $T_{j} \leq T_{JMAX}$ $_{J} = 25$ °C, $I_{D} = 37.5$ A, $V_{DD} = 30$ V	MMM.100, MMM.100	ox.com

Current limited by package

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Thermal data Table 3.

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le 3.	Thermal data		TO STOOM
Symbol	Parameter	Value	Unit
R <sub>thJC</sub>	Thermal resistance junction-case Max	0.5	°C/W
R <sub>thJA</sub>	Thermal resistance junction-ambient Max	62.5	°C/W
CD)M	Maximum lead temperature for soldering purpose	300	°C

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Pulse width limited by safe operating area

 $I_{SD} \le 75A$ , di/dt  $\le 500A/\mu s$ ,  $V_{DD} \le V_{(BR)DSS}$ ,  $T_j \le T_{JMAX}$ 

NWW.100Y.COM.TV Starting  $T_J = 25$  °C,  $I_D = 37.5A$ ,  $V_{DD} = 30V$ 

MMM.100Y.COM.TM N.100X.COM.TW **Electrical characteristics** STB75NF75L 100X.COM

# W.100Y.COM.TW **Electrical characteristics** 2

Table 4. On/off states

T <sub>CASE</sub> =2: [able 4.	5°C unless otherwise spec On/off states	ified)				
Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V <sub>(BR)DSS</sub>	Drain-source breakdown voltage	$I_D = 250 \mu A, V_{GS} = 0$	75	M.TV	J	٧
I <sub>DSS</sub>	Zero gate voltage drain current (V <sub>GS</sub> = 0)	V <sub>DS</sub> = Max rating, V <sub>DS</sub> = Max rating @ 125°C	N.C.	OM.	1 10	μ <b>Α</b> μ <b>Α</b>
I <sub>GSS</sub>	Gate body leakage current (V <sub>DS</sub> = 0)	V <sub>GS</sub> = ±15V	1001	$CO_{N_{s}}$	±100	nA
V <sub>GS(th)</sub>	Gate threshold voltage	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	100	1.0	2.5	٧
R <sub>DS(on)</sub>	Static drain-source on resistance	$V_{GS}$ = 10V, $I_{D}$ = 37.5A $V_{GS}$ = 5V, $I_{D}$ = 37.5A	W.7	0.009 0.010	0.011 0.013	Ω

Symbol	Parameter	Test conditions	Min.	Тур.	Max.
g <sub>fs</sub> (1)	Forward transconductance	$V_{DS} = 15V, I_D = 37.5A$	M	120	
C <sub>iss</sub> C <sub>oss</sub> C <sub>rss</sub>	Input capacitance Output capacitance Reverse transfer capacitance	$V_{DS} = 25V, f = 1 \text{ MHz}, V_{GS} = 0$		4300 660 205	N.100
$egin{array}{c} Q_{ m g} \ Q_{ m gd} \end{array}$	Total gate charge Gate-source charge Gate-drain charge	$V_{DD} = 60V$ , $I_D = 75A$ $V_{GS} = 5V$ see Figure 15	N	75 18 31	90

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Symbol t <sub>d(on)</sub>	Parameter	Test conditions	Min.	Typ.	Max.	Unit
t <sub>r</sub>	Turn-on delay time Rise time	$V_{DD} = 40V, I_D = 37.5A,$ $R_G = 4.7\Omega, V_{GS} = 4.5V$	T.M.T	35 155		ns ns
t <sub>d(off)</sub>	Turn-off delay time	see <i>Figure 14</i>		110		ns
t <sub>f</sub>	Fall time	see Figure 14	CON	60	-1	ns

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Source drain diode

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Sym	bol	Parameter	Test conditions	Min	Тур.	Max	Unit
Is	o Se	ource-drain current	TAN Jun COM		V	75	Α
I <sub>SDN</sub>	1 <sup>(1)</sup> S	ource-drain current (pulsed)	A A TAN TON TOO	Nr.	N	300	Α
V <sub>SE</sub>	, <sup>(2)</sup> Fo	orward on voltage	$I_{SD} = 75A, V_{GS} = 0$	$\Omega_{Mr}$	TW	1.3	V
t <sub>r</sub> Q	r R	everse recovery time everse recovery charge everse recovery current	$I_{SD} = 75A$ , $di/dt = 100A/\mu s$ , $V_{DD} = 24V$ , $T_{J} = 150$ °C see <i>Figure 16</i>	(CO)	120 500 9	TN TN	ns nC A

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Pulse width limited by safe operating area

Pulsed: pulse duration=300µs, duty cycle 1.5% WWW.100X.COM.

Electrical characteristics STB75NF75L

#### 2.1 Electrical characteristics (curves)

Figure 2. Safe operating area

Figure 3. Thermal impedance

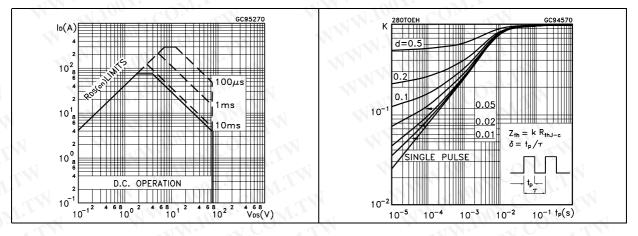


Figure 4. Output characteristics

Figure 5. Transfer characteristics

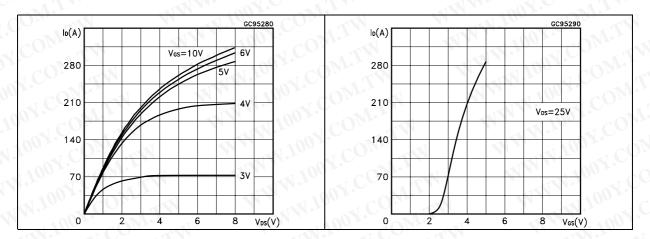
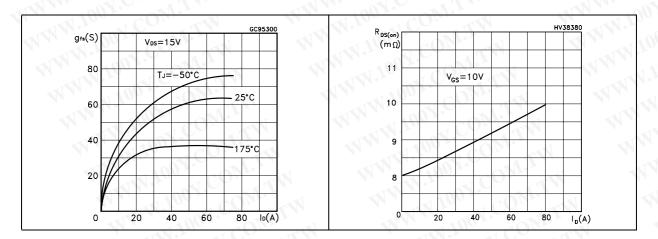


Figure 6. Transconductance

Figure 7. Static drain-source on resistance



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Figure 8. Gate charge vs gate-source voltage Figure 9. Capacitance variations

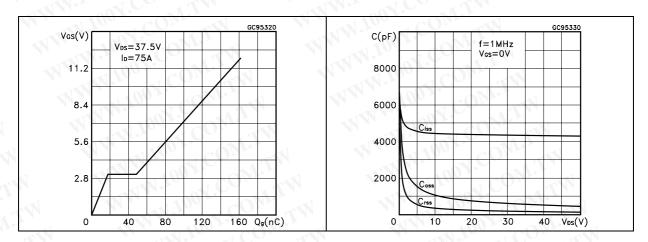


Figure 10. Normalized gate threshold voltage vs temperature

Figure 11. Normalized on resistance vs temperature

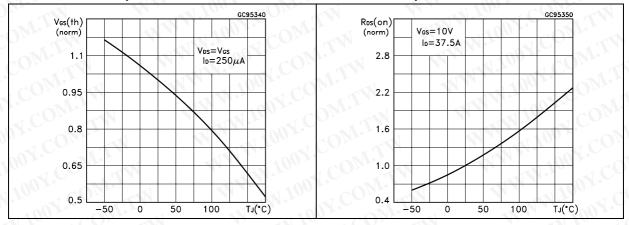
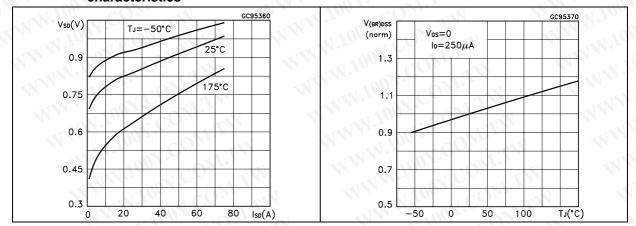


Figure 12. Source-drain diode forward characteristics

Figure 13. Normalized B<sub>VDSS</sub> vs temperature



Test circuit STB75NF75L

#### 3 Test circuit

Figure 14. Switching times test circuit for resistive load

Figure 15. Gate charge test circuit

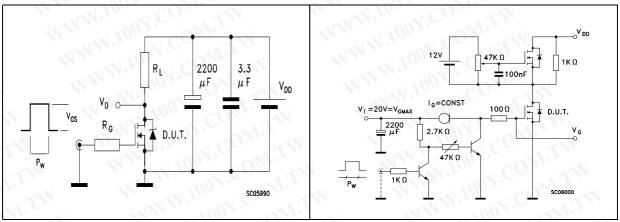


Figure 16. Test circuit for inductive load switching and diode recovery times

Figure 17. Unclamped Inductive load test circuit

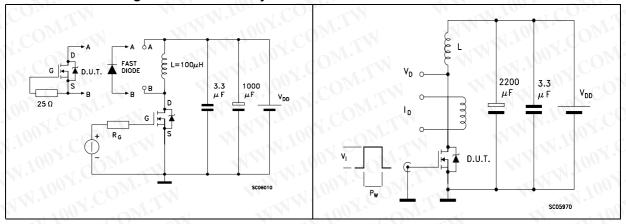
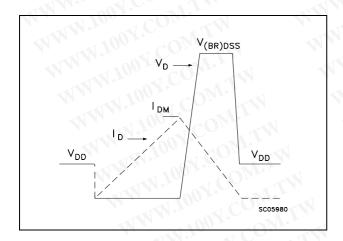


Figure 18. Unclamped inductive waveform



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#### 4 Package mechanical data

In order to meet environmental requirements, ST offers these devices in ECOPACK® packages. These packages have a Lead-free second level interconnect. The category of second level interconnect is marked on the package and on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label. ECOPACK is an ST trademark. ECOPACK specifications are available at: www.st.com

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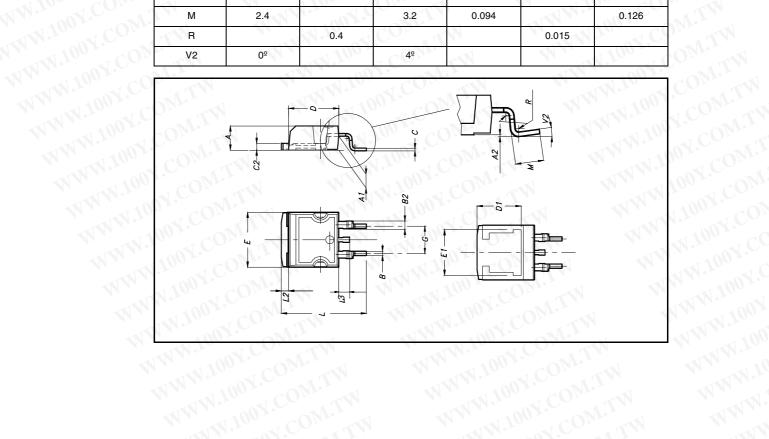
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#### D<sup>2</sup>PAK MECHANICAL DATA

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DIM.		mm.		POX:	inch	
DIM.	MIN.	TYP	MAX.	MIN.	TYP.	MAX.
A	4.4	N	4.6	0.173	Olympia and	0.181
A1	2.49	×N	2.69	0.098	OM	0.106
A2	0.03		0.23	0.001	OM.T	0.009
В	0.7	TIM	0.93	0.027	Co	0.036
B2	1.14	W	1.7	0.044	*1 COM	0.067
С	0.45		0.6	0.017	COM	0.023
C2	1.23	OM:T	1.36	0.048	001.	0.053
D	8.95		9.35	0.352	011.00	0.368
D1	11.100	0 8			0.315	
E	10	COM	10.4	0.393	1100	OM
E1	N	8.5	. 1		0.334	
G	4.88		5.28	0.192	111.	0.208
L	15	CO	15.85	0.590	MIN. Too	0.625
L2	1.27	700, 100	1.4	0.050	10	0.055
L3	1.4	1007.	1.75	0.055	NW TA	0.068
М	2.4	11.	3.2	0.094		0.126
R		0.4	COS		0.015	Jo-
V2	Oō	100	4º	~XN	11/4	1000



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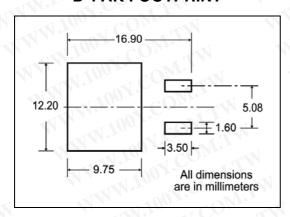
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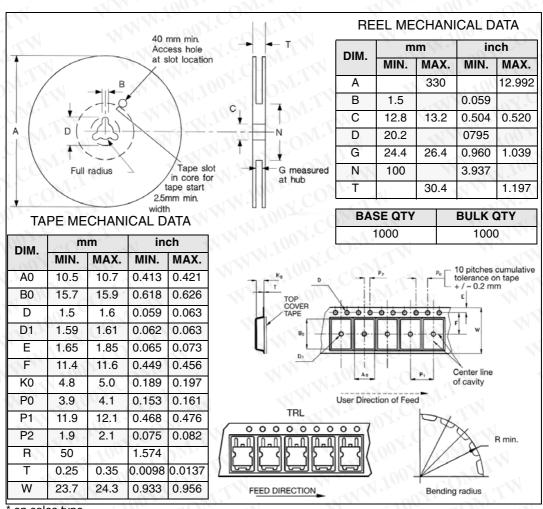
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# 5 Packaging mechanical data D<sup>2</sup>PAK FOOTPRINT



#### TAPE AND REEL SHIPMENT



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## **Revision history** WWW.1

Table 8. **Revision history** 

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Date	Revision	Changes
21-Jun-2004	M. T	First release
02-Oct-2006	2	New template, no content change
13-Jul-2007	3	New updates on <i>Table 7</i>

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